

# **Round Robin Testing and Analysis of Lead Free Solder Pastes with Alloys of Tin, Silver and Copper**

## **Final Report**

A Research Report by the Lead Free Technical Subcommittee  
IPC SOLDER PRODUCTS VALUE COUNCIL

## IPC Solder Products Value Council Mission Statement

In support of IPC's mission statement, IPC solder manufacturers recognize that the PCB and electronics assembly industries, comprised of the entire supply chain, must grow profitably. The IPC Solder Products Value Council (SPVC) Steering Committee's objective is to identify and execute programs designed to enhance the competitive position of solder manufacturers and their customers.

## Acknowledgement

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